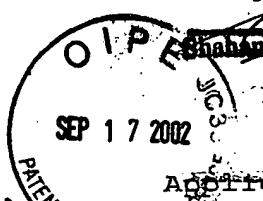


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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

SEP 17 2002

Applicant: Minoru Nakano, et al. Group Art Unit: 2825

Serial No.: 09/675,220

Examiner: Everhart, Caridad

Filed: September 29, 2000

Attorney Docket No.: 3094/FLK

For: METHOD AND APPARATUS FOR CONTROLLING A SEMICONDUCTOR
FABRICATION TEMPERATURE

Honorable Commissioner for Patents

Washington, D.C. 20231

#5 Handled
9/24/02
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A M E N D M E N T

Dear Sir:

In response to the Office Action dated May 14, 2002,
please amend the above-identified application as follows:

IN THE CLAIMS:

Please cancel claim 13.

Please amend claims 8, 10 and 14 as follows:

8. (Amended) The method of claim 5, wherein a controlled power output for a heating source is determined by